

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4578542

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DONG-SHENG LI	08/10/2017
KUANG-FENG LIN	08/10/2017
CHING-PAO HSIAO	08/10/2017
GEN-JIE HSIAO	08/10/2017
CHEN-SHENG LEE	08/10/2017
RECEIVING PARTY DATA	
Name:	SIMPOWER TECHNOLOGY INC.
Street Address:	9F.-1, NO. 461, SEC. 6, NANJING E. RD., NEIHU DIST.
City:	TAIPEI CITY
State/Country:	TAIWAN
Postal Code:	11469
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15176260
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	ahuang@pypat.com
Correspondent Name:	ANGELA HUANG
Address Line 1:	OFFICE 210, 1250 OAKMEAD PARKWAY
Address Line 4:	SUNNYVALE, CALIFORNIA 94085
ATTORNEY DOCKET NUMBER:	AN6017N_089-16-0024.IUS
NAME OF SUBMITTER:	ANGELA HUANG
SIGNATURE:	/Angela Huang/
DATE SIGNED:	09/05/2017
Total Attachments: 3	
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source=AN6017N_Assignment_Agreement#page2.tif	

THIS AGREEMENT is made
on

Date 2017/08/10

by and between

Assignor Name(s)

Assignor 1: LI, DONG-SHENG
Address: 9F.-1, NO.461, SEC. 6, NANJING
E. RD., NEIHU DIST., TAIPEI CITY 11469
TAIWAN

Assignor 2: LIN, KUANG-FENG
Address: 9F.-1, NO.461, SEC. 6, NANJING
E. RD., NEIHU DIST., TAIPEI CITY 11469
TAIWAN

Assignor 3: HSIAO, CHING-PAO
Address: 9F.-1, NO.461, SEC. 6, NANJING
E. RD., NEIHU DIST., TAIPEI CITY 11469
TAIWAN

Assignor 4: HSIAO, GEN-JIE
Address: 9F.-1, NO.461, SEC. 6, NANJING
E. RD., NEIHU DIST., TAIPEI CITY 11469
TAIWAN

Assignor 5: LEE, CHEN-SHENG
Address: 9F.-1, NO.461, SEC. 6, NANJING
E. RD., NEIHU DIST., TAIPEI CITY 11469
TAIWAN

Assignor Address(es)

and

Assignee Name(s)

SIMPOWER TECHNOLOGY INC.

Assignee Address(es)

9F.-1, NO.461, SEC. 6, NANJING E. RD.,
NEIHU DIST., TAIPEI CITY 11469
TAIWAN

WHEREAS, the undersigned have invented certain new and useful improvements in the below invention (the "Invention"):

Title of the Invention

Multi-functional hub integrated with ac
power supply

Application Number

15/176,260

NOW THEREFORE, in consideration of the mutual promises, covenants, warranties, and other good and valuable consideration set forth herein, the receipt of which is hereby acknowledged, and in accordance with applicable law, the undersigned:

I. Hereby sell, assign and transfer to Assignee its successors, assigns and legal representatives, the entire right, title and interest for the United States and all-foreign countries, in and to any and all inventions which are disclosed in the application for united States Letters Patent executed of even date herewith and entitled above and in and to said application and all divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent which have been or shall be filed in the United States and all

foreign countries on any of the said inventions; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said inventions including the right to apply for patent rights in each foreign country and all rights to priority;

2. Hereby agree that said Assignee may apply for and receive Letters Patent for said inventions in its own name; and when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, agree to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions; execute all rightful oaths, assignments, power of attorney and other papers, communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said inventions and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and for vesting title to said inventions and all applications for patents and all patents on said inventions, in said Assignee, its successors, assigns and legal representatives;

3. Hereby request the Honorable Commissioner of Patents to issue said Letters Patent to said Assignee; and

4. Covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned and that full right to convey the same as herein expressed is possessed by the undersigned.

[SIGNATURE PAGE FOLLOWS]

IN WITNESS WHEREOF, executed by the ASSIGNOR on the date opposite the ASSIGNOR names.

LEGAL NAME OR COMPANY NAME OF the ASSIGNOR

ASSIGNOR 1:

LI DONG-SHENG

Signature:



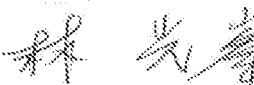
Date:

2017/08/10

ASSIGNOR 2:

LIN KUANG-FENG

Signature:



Date:

2017/08/10

ASSIGNOR 3:

HSIAO CHING-PAO

Signature:



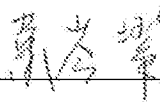
Date:

2017/08/10

ASSIGNOR 4:

HSIAO GEN-JIE

Signature:



Date:

2017/08/10

ASSIGNOR 5:	<u>LEE.CHEN-SHENG</u>		
Signature:	<u>lee.chen-sheng</u>	Date:	<u>2017/08/10</u>